

ITRPV 10th edition 2019 - report release and key findings

Markus Fischer

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Penang, Malaysia

Outline



1. **ITRPV – Status and PV learning Curve**
2. **ITRPV – Results 2018**
 - **Wafer** - **Products, Materials, Processes**
 - **Cell** - **Products, Materials, Processes**
 - **Module** - **Products, Materials, Processes**
 - **Systems**
3. **Outlook and Summary**

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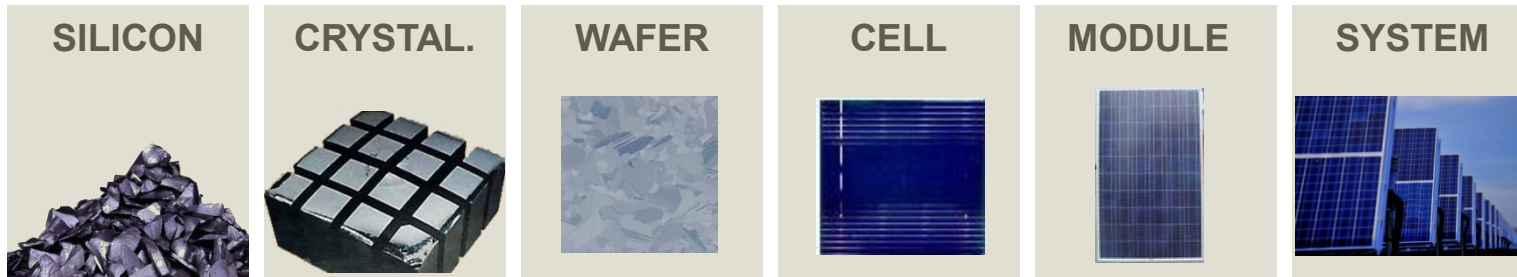
3. Outlook and Summary

ITRPV – Methodology / Statistics

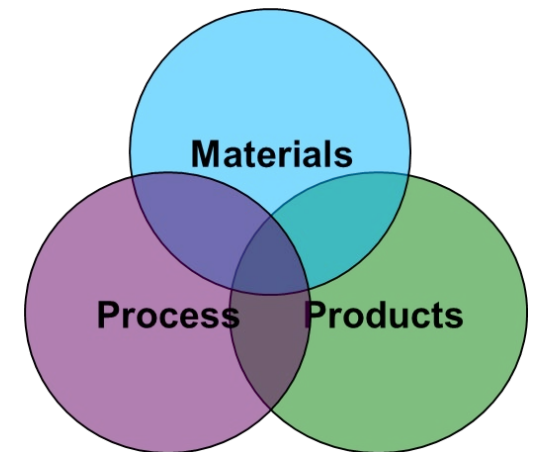


10th edition: 55 contributors from Asia, Europe, and US

Figures o/a: 90 (71)
 Materials: 19 (16)
 Processes: 29 (21)
 Products: 20 (14)
 PV systems: 9 (8)



Chairs US
Chairs PRC
Chairs TW
Chairs US

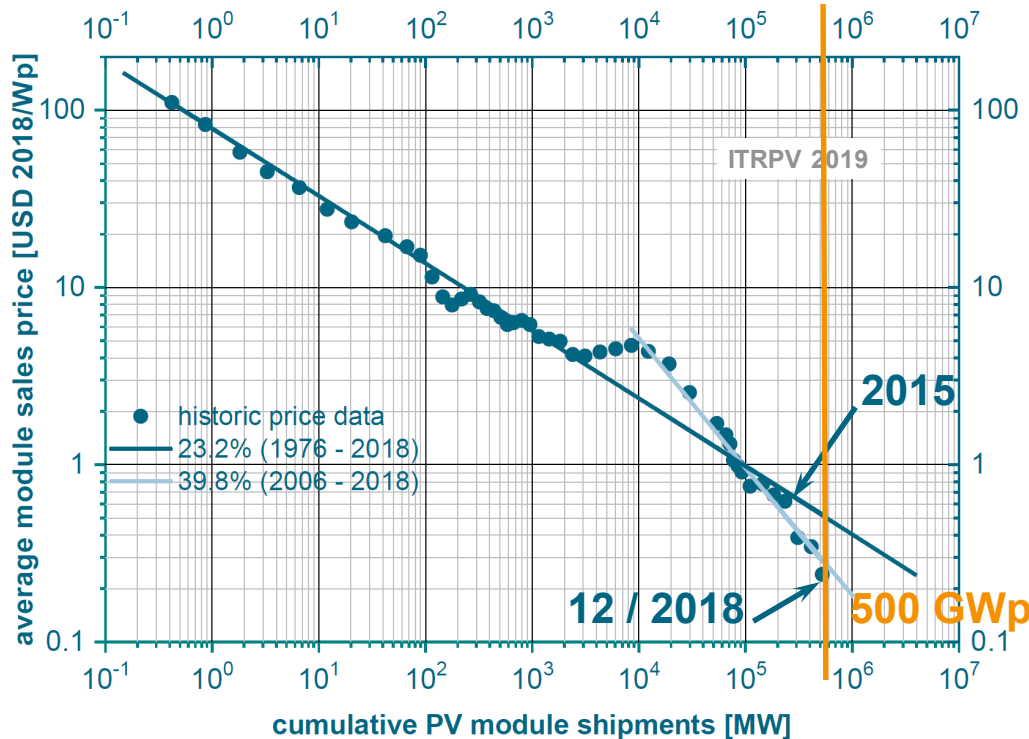


Parameters in main areas are discussed → Diagrams of median values

PV learning curve



Learning curve for module price as a function of cumulative shipments



Shipments /avg. price at years end:

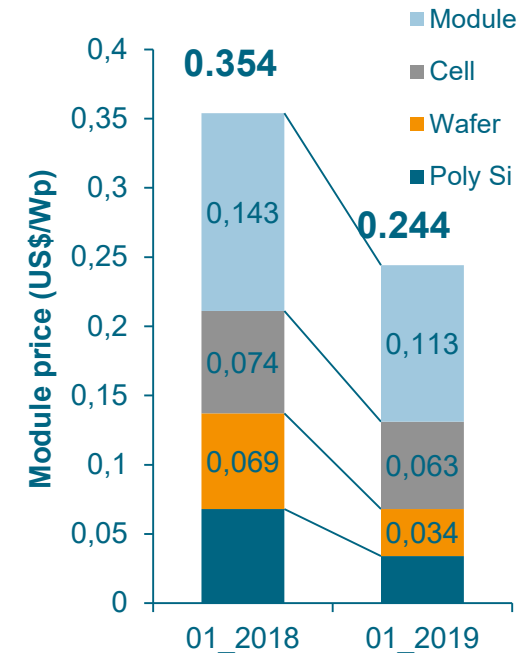
2017: 105 GWp / 0.35US\$/Wp
 2018: 109 GWp / 0.24 US\$/Wp



o/a shipment: ≈ 523 GWp
 o/a installation: ≈ 504 GWp

0.5 TWp milestone passed!

LR ≈ 23 % (1976 2018)
 LR ≈ 40 % (2006 2018)



→ Stable volume shipped with **huge** price deterioration

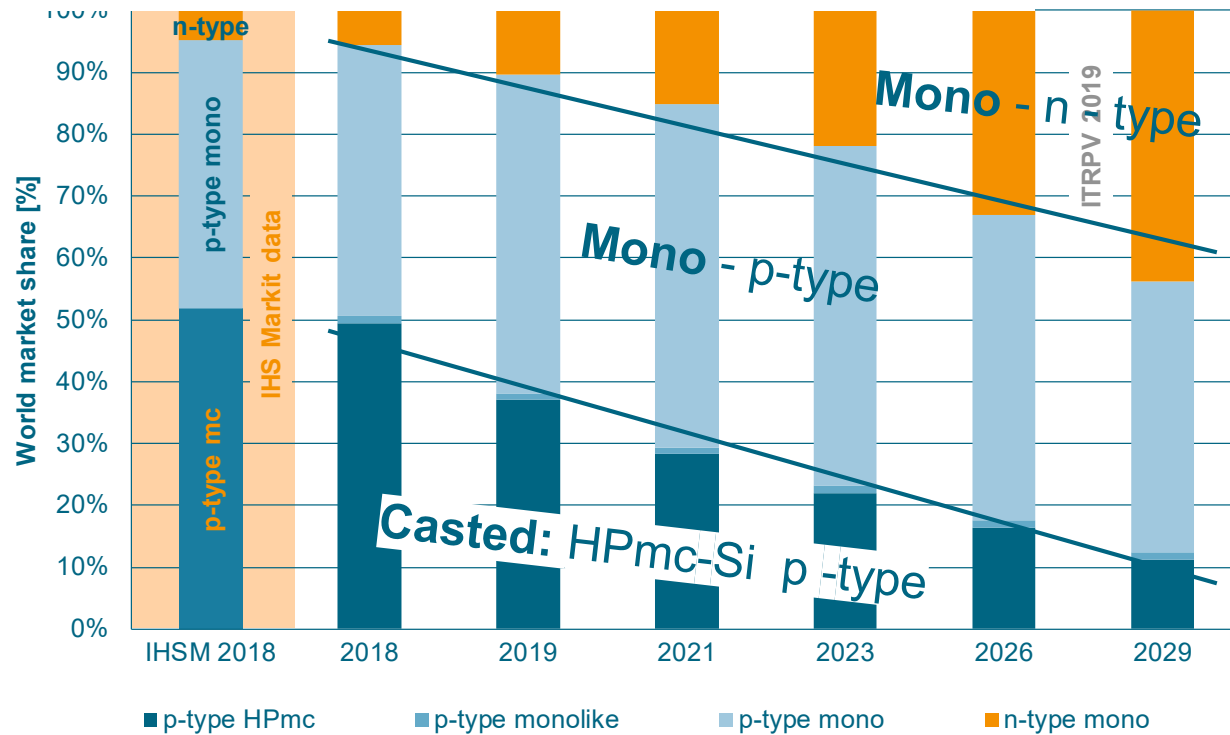
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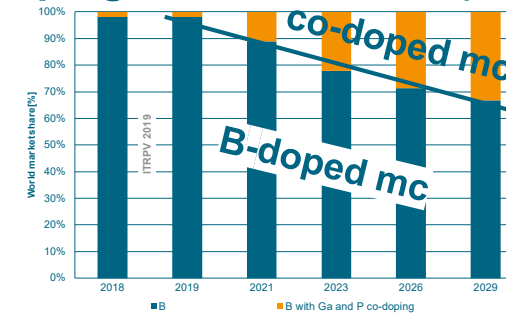
Wafer: Product –market share of wafer type

Trend: share of c-Si material types



→ **Mono will dominate** (further boost by n-type)

- **p-type material will stay mainstream until 2029**
→ base for p-PERC technology
- **casted-Si share shrunk to 50%:**
→ Dominance is gone,
→ p-type **HP** mc-Si is dominating
→ mono-cast @ 1%
→ **co-doping with Ga/P** will improve ingot quality



- **Mono technology will fast gain market share:**
→ n- + p-type ≈60% in 2019
→ n-type material share will increase (HJT, Topcon)
→ p-type will stay mainstream
Ga doping expected to improve

- **2018 values in line w/ IHS Market analysis**

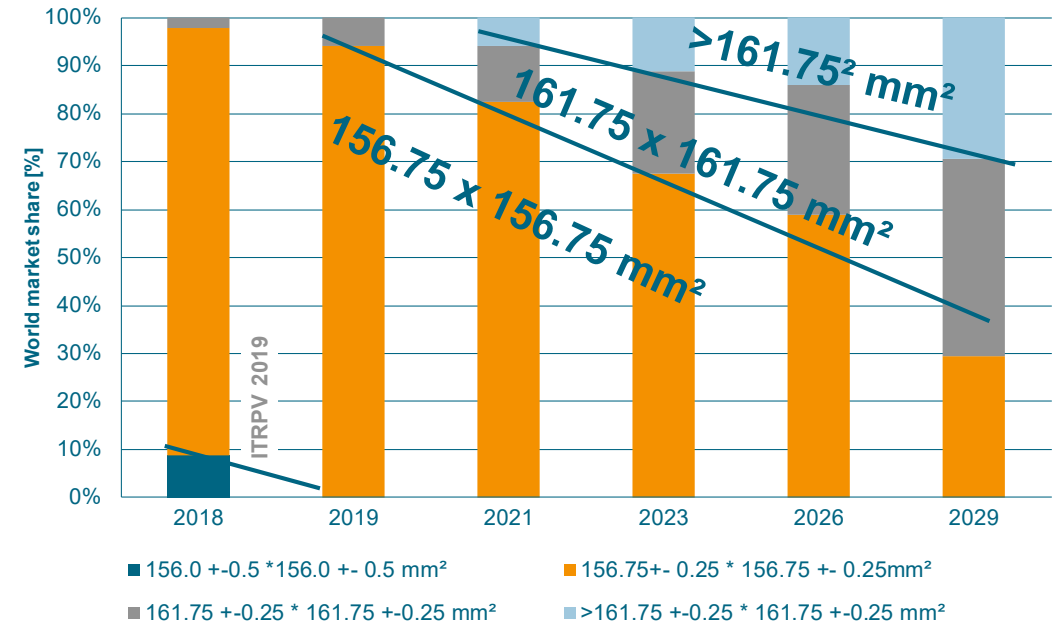
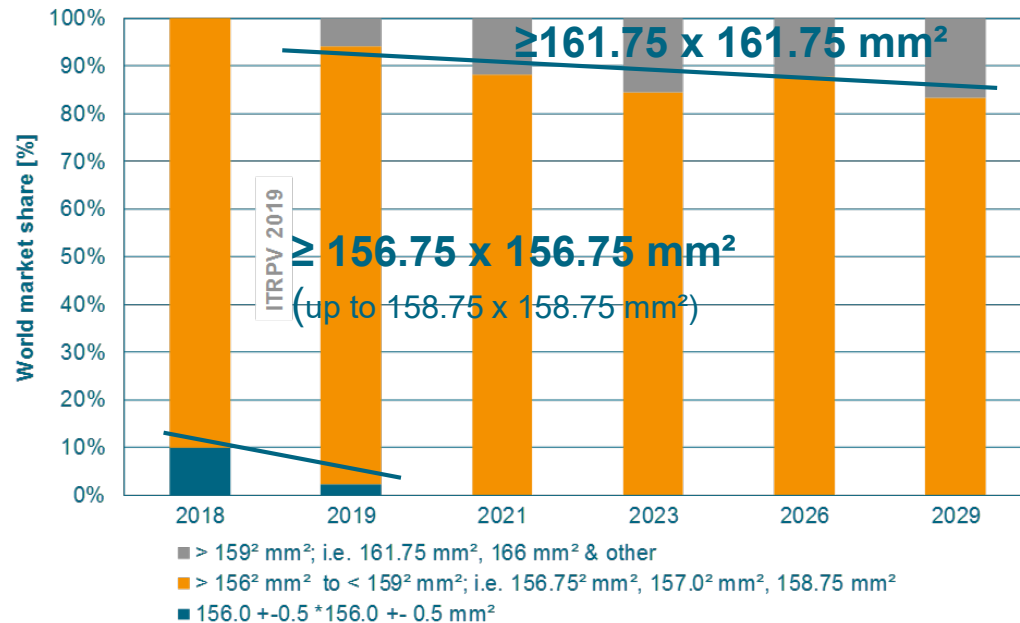
Wafer: Product - market share of wafer sizes

Trend: mc-Si wafer size

→ several new formats appear

Trend: mono-Si wafer size

→ Mono will soon use $\geq 161.75 \times 161.75 \text{ mm}^2$

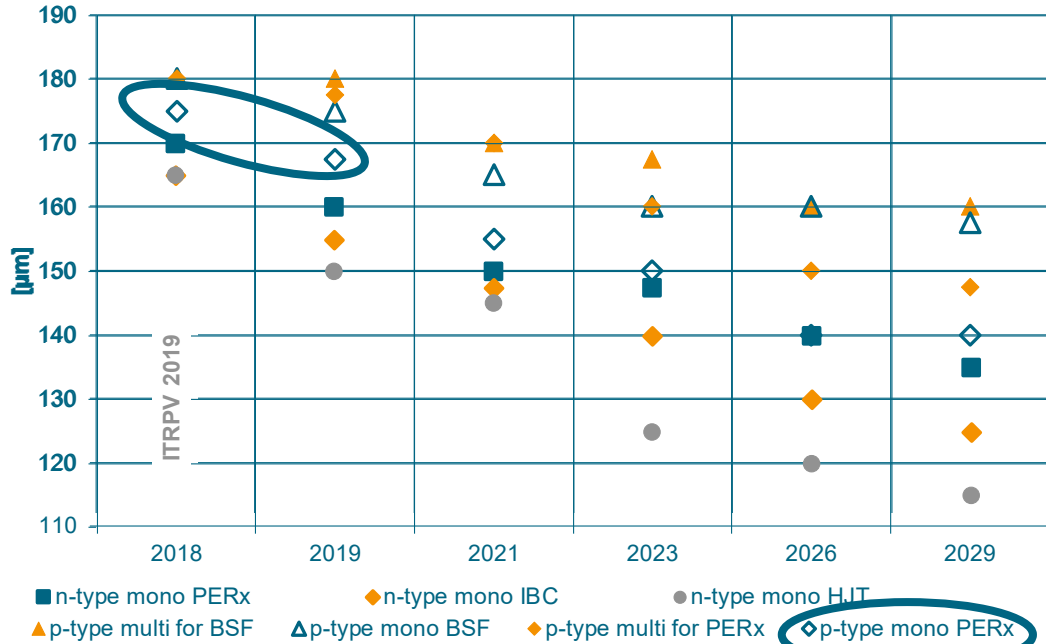


- **$\geq 156.75 \times 156.75 \text{ mm}^2$ is mainstream now!**
 - $156 \times 156 \text{ mm}^2$ - disappeared
 - $161.75 \times 161.75 \text{ mm}^2$ require upgrades of existing lines and larger modules**
 - new tools/fabs for even larger wafers
- Standardization is required**

Wafer: Process – crystallization / wafering technology



Trend: wafer thickness



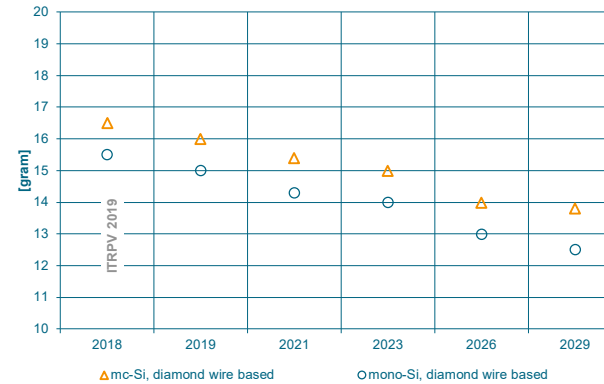
- **mono wafer thickness is reducing now!**

2019 2029

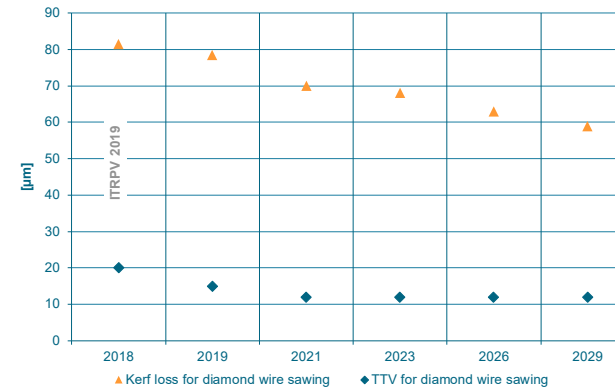
→ p-type $\approx 170\mu\text{m}$ today, → $140\mu\text{m}$ driven by PERx
 → n-type $\approx 150\mu\text{m}$ today, → $115\mu\text{m}$ HJT leads
 → mc-Si still delayed

→ **Diamond wire** sawing is the only wiring technology

Trend: poly-Si utilization / kerf loss



- Poly-Si utilization:
 → $\approx 16.5\text{g}$ / mono-Si wafer
 → $\approx 15.5\text{g}$ mc-Si wafer



- kerf loss
 → $\approx 80\mu\text{m}$ 2019
 → $\approx 60\mu\text{m}$ 2029
- TTV
 → will improve to $10\mu\text{m}$

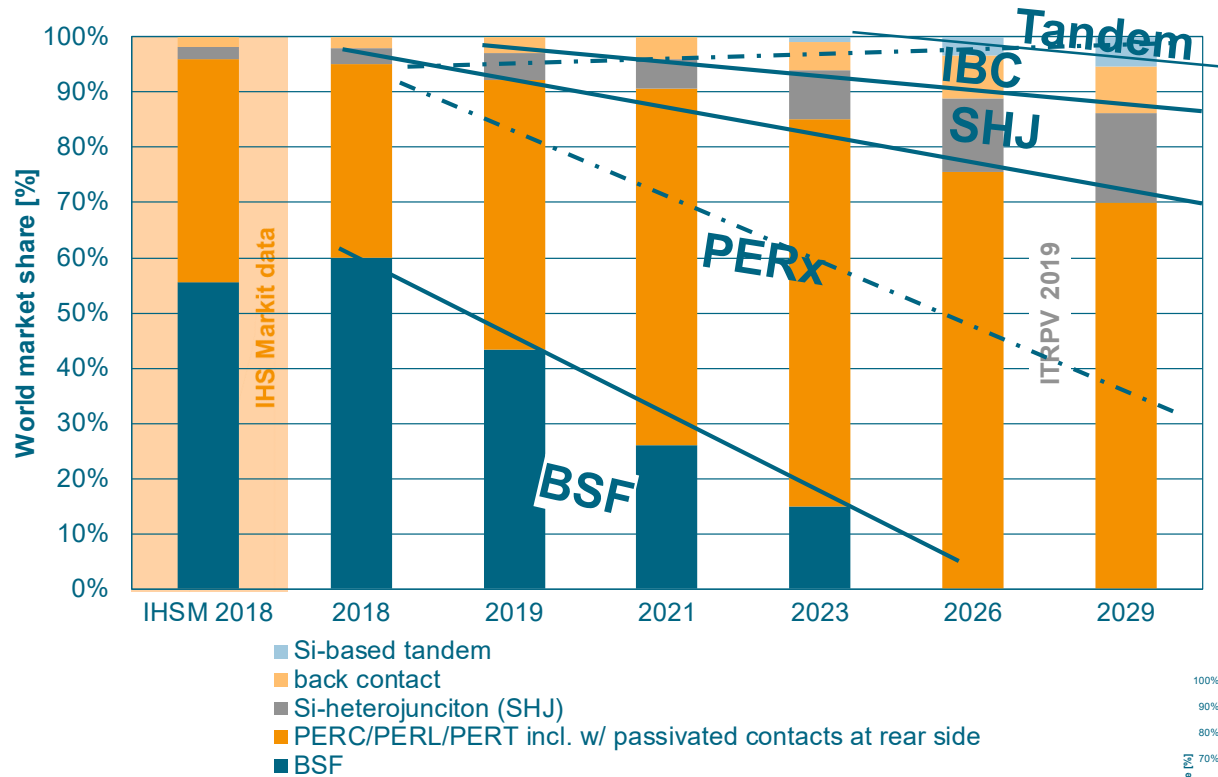
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Cell: Product – market share of cell technologies

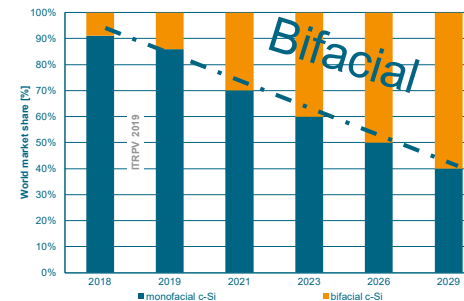
Trend: share of cell technologies



→ **PERx - technologies will dominate**
(2018 ITRPV data are close to IHS Markit)

- **BSF**
 - ≈40% share in 2019
 - focus on mc-Si BSF
 - will disappear after 2025
- **PERx (incl. passivated contacts)**
 - >50% share in 2019
 - market mainstream in coming years
 - on p- and n- type
- **Si- heterojunction (SHJ)**
 - ≈2% in 2018 → >15% in 2029
 - on n-type only
- **Back contact concepts**
 - ≈2 % in 2018 → 10% in 2029
- **Si-Tandem** expected from 2023 onwards

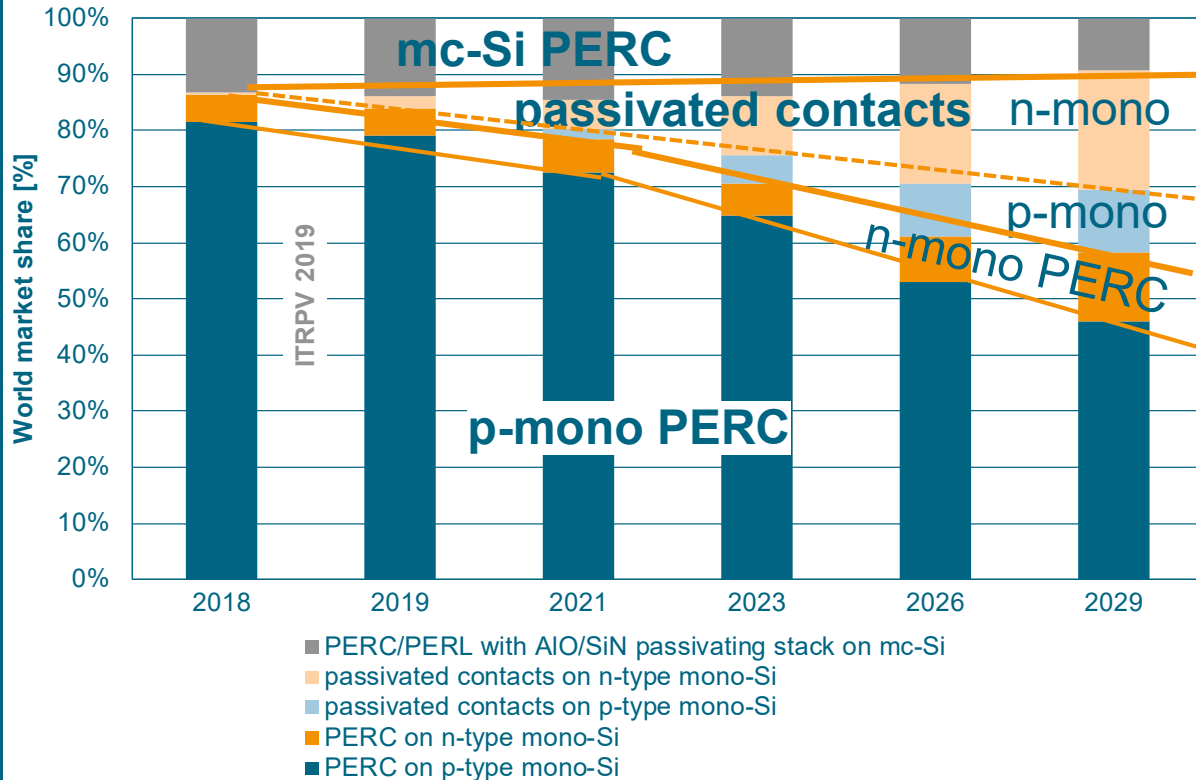
fit
for
Bifacial



Bifacial cells will gain share
→ ≈15% in 2019
→ ≈60% in 2029

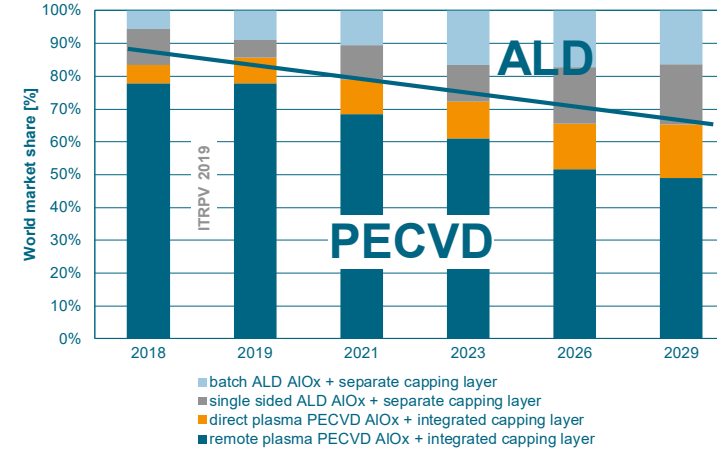
Cell: Process – market share of PERx cell technologies

Trend: Passivated Emitter and Rear concepts

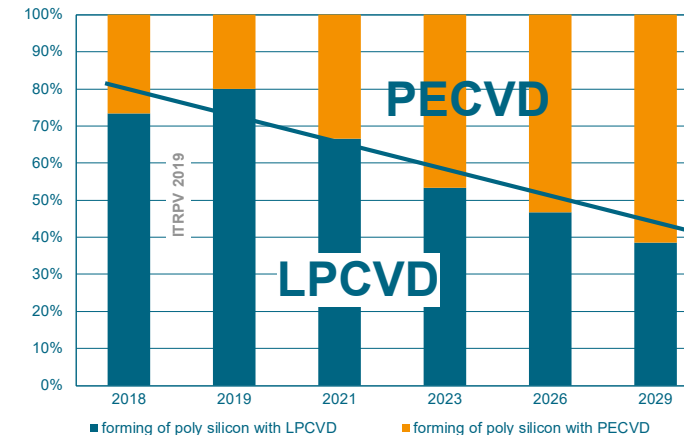


- PERC with AIO/SiN stack is mainstream
- Passivated contact concepts will gain market share

Trend: rear passivation processes



- PERC (with contacts) → PECVD (AIOx/SiN) = mainstream
- ALD AIOx = will gain market



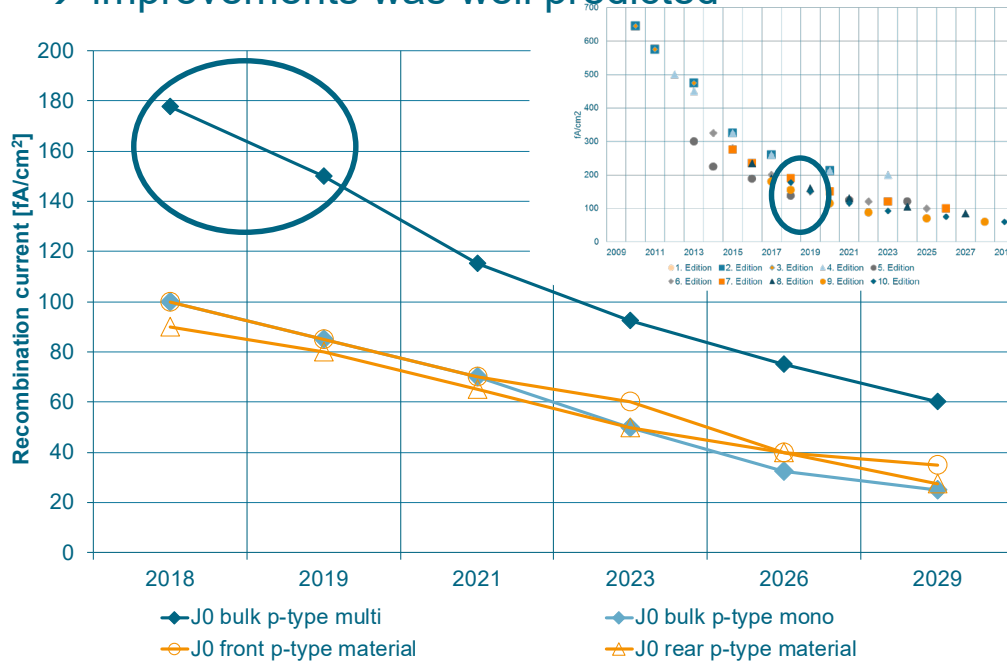
- Passivated contacts - poly-Si deposition: → LPCVD vs. PECVD
- tunnel oxide forming → in-situ preferred
- poly-Si doping → in-situ preferred

Cell: Process– recombination losses



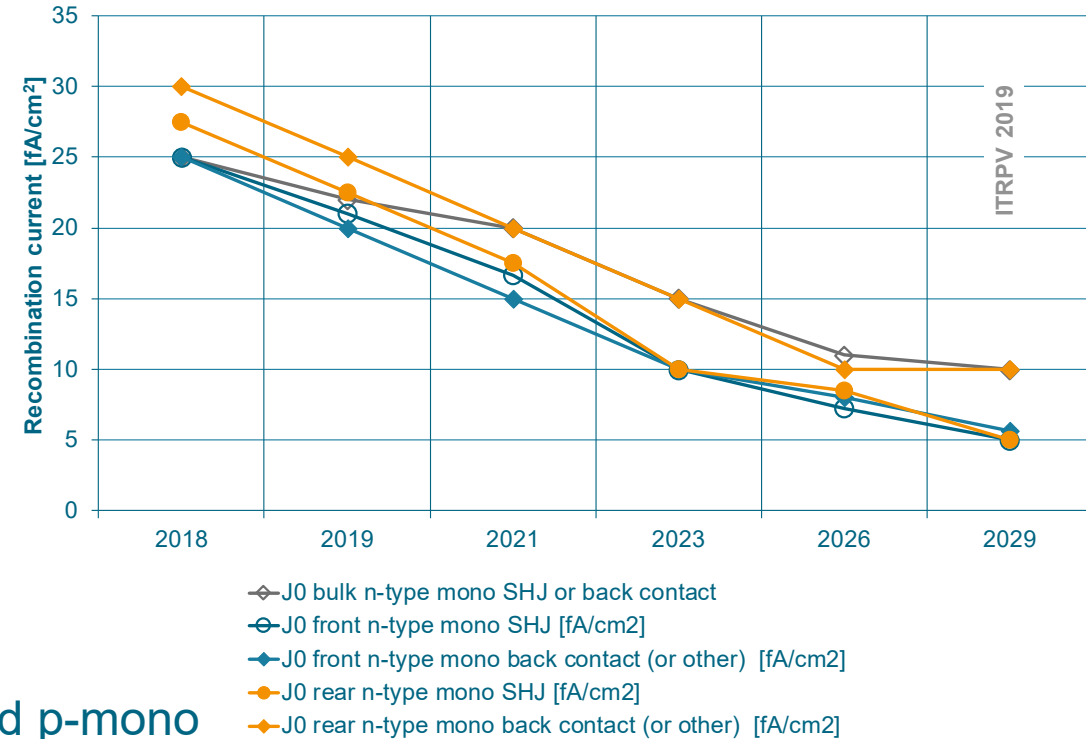
Trend: J0 p-type materials

→ improvements was well predicted



Trend: J0 n-type materials

→ n-type has much lower J0



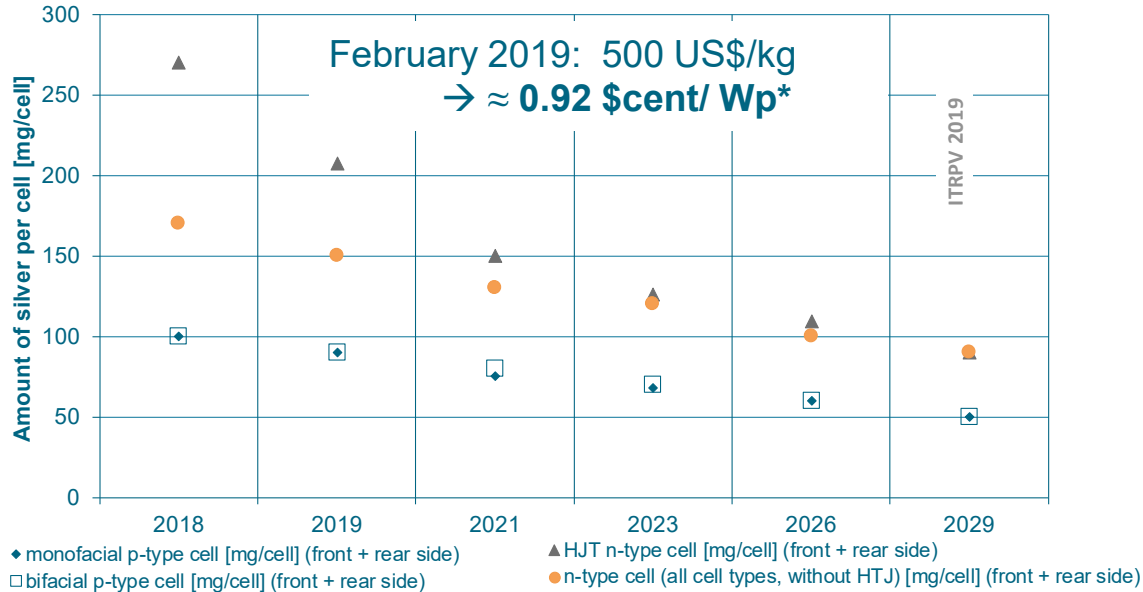
2018
J0 bulk: p-mc-Si 178 fA/cm² → 90 fA/cm² ≈ 5y behind p-mono
 p-mono 100 fA/cm² → 50 fA/cm² ≈ 10y behind n-mono
n-mono 25 fA/cm² → 10 fA/cm²
 J0 front/rear → close to mono bulk values

Cell: Process – metallization trends

2019: $20.25\% \times 0.987 \text{ (CTM)} \approx 4.91\text{W/cell}^*$
 $\rightarrow \approx 18.3 \text{ t / GWp}$
 $\rightarrow \approx 18300 \text{ t @100GW} = 6.3\% \text{ of world Silver market 2017}^{**}$
 Photography 1996: 40% of annual Silver market^{**}



Trend: remaining Silver (predictions were met)



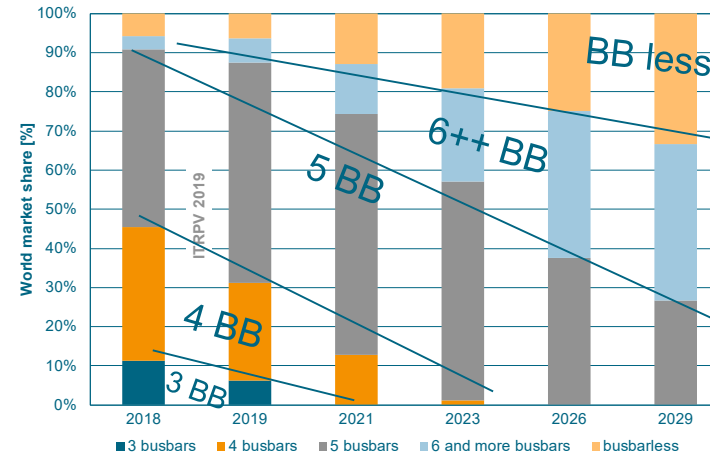
Silver reduction will continue

- 90mg Ag for p-type cells
- n-type concepts use more Ag

Measures: - reduction of finger width → more bus bars

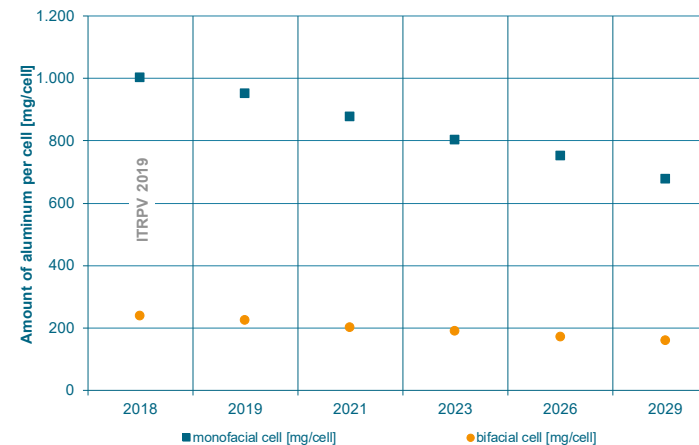
- finger width $40\mu\text{m} \rightarrow 20\mu\text{m}$ in 2029
- Single print will remain mainstream

Trend: number of bus bars



- **BB trend:**
 $\rightarrow 5 \text{ BB+ is mainstream}$
 $\rightarrow 3/4 \text{ BB will disappear}$

Trend: remaining Aluminum



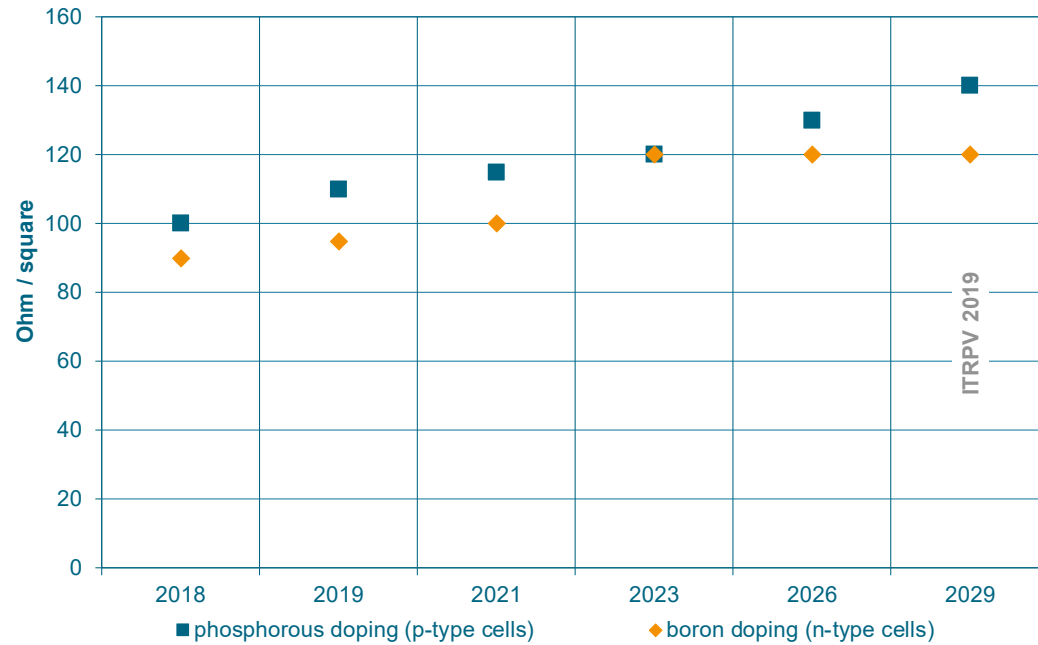
- **Rear side Al trend:**
 $\rightarrow 1 \text{ g for mono-facial}$
 $\rightarrow \text{Bifacial uses 20\% only}$

* avg. module power 290W labeled ; ** Assumption $\approx 29,000\text{t} / 1018 \text{ MOz 2017 market}$ <https://www.silverinstitute.org/publications/>

Cell: Process – emitter doping

Trend: emitter sheet resistance

Sheet resistance will increase further

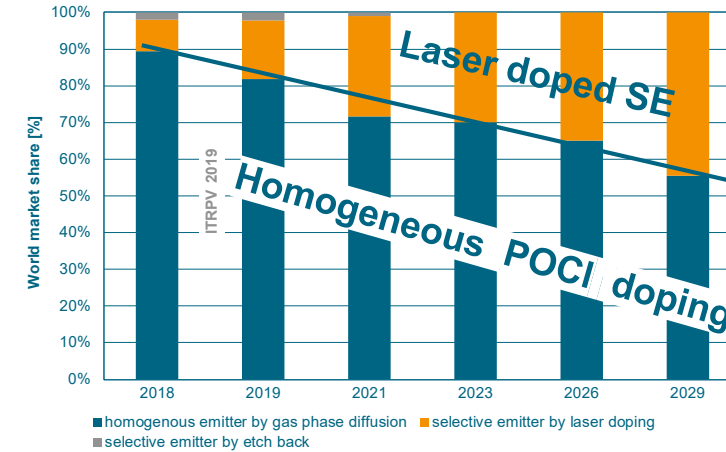


P-doping: 2018: 100 Ω/\square → 2029 140 Ω/\square
 → selective emitter use will be intensified

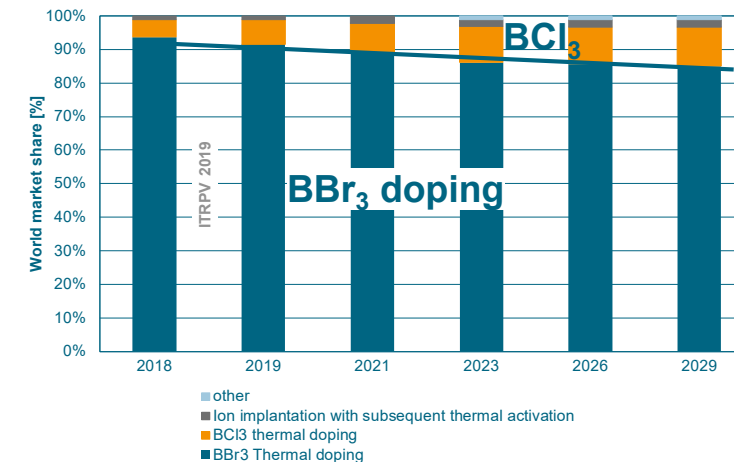
B-doping: 2018: 90 Ω/\square → 2029 120 Ω/\square

Trend: doping processes

→ P-doping: selective emitter will gain



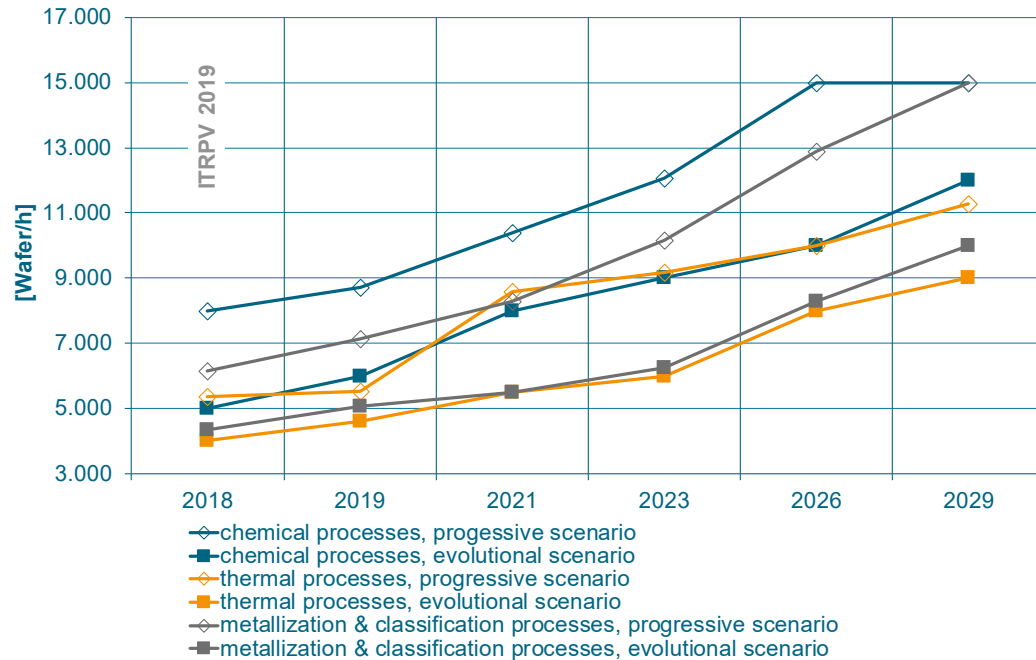
→ B-doping: BBr_3 is mainstream



Cell: Process – throughput / OEE / smart fab trends

Trend: cell process tool throughput

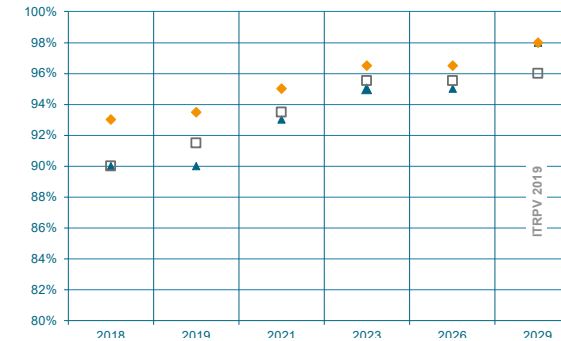
- wet will lead the throughput increase
- metallization will impressively improve



→ Thermal processing is behind

Trend: OEE 2018/ 2025

- chemical is leading: 93% / 96%
- thermal and metallization: 90% / 95%



Trend: WIP tracking standard

- carrier and wafer tracking
- link cell to module tracability

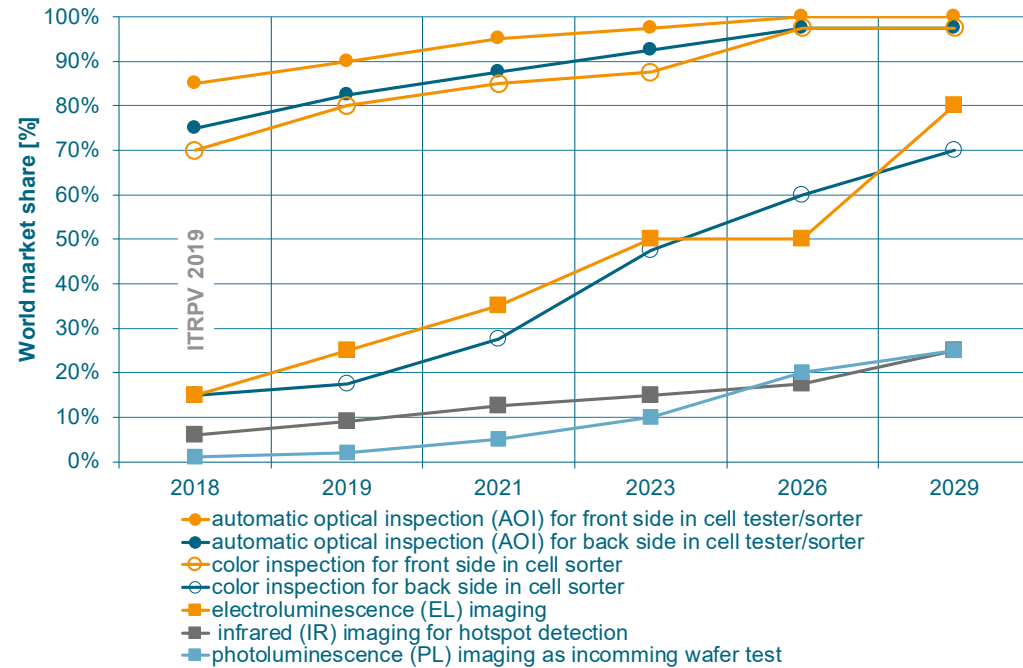


Cell: Process – in-line process control /MES



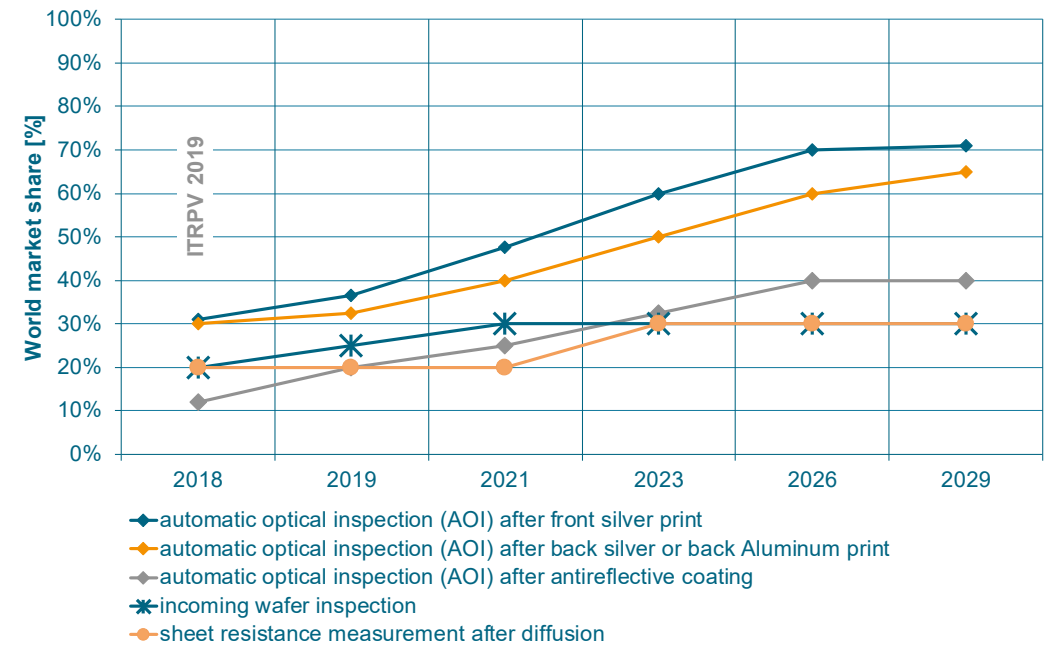
Trend: inspection at cell test

- AOI in cell test is standard → 100% in 2025
- EL on cell level is increasing market



Trend: in-line process control

- printer inspection will gain share
- other inspection at low share

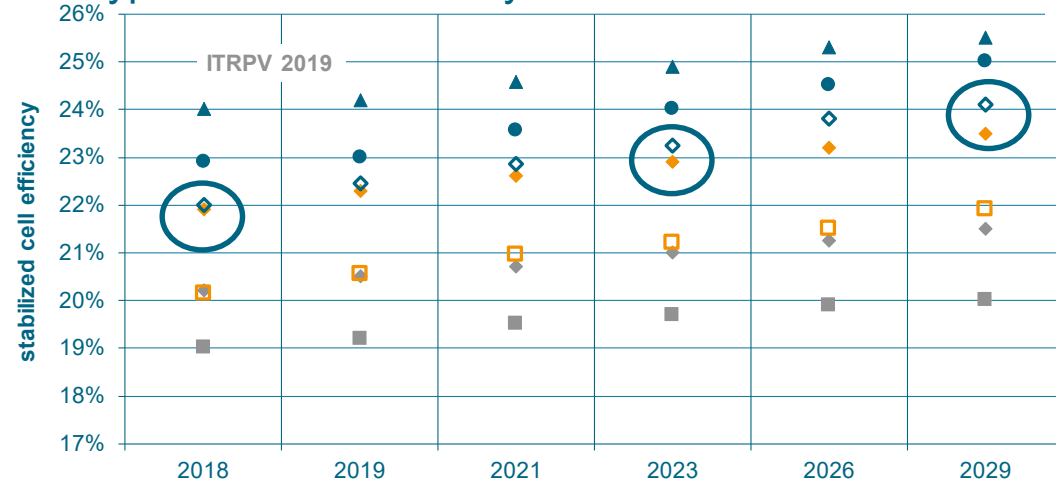


Cell: Product – cell efficiencies in mass production



Trend: cell efficiency

→ n-type leads in efficiency with SHJ and IBC

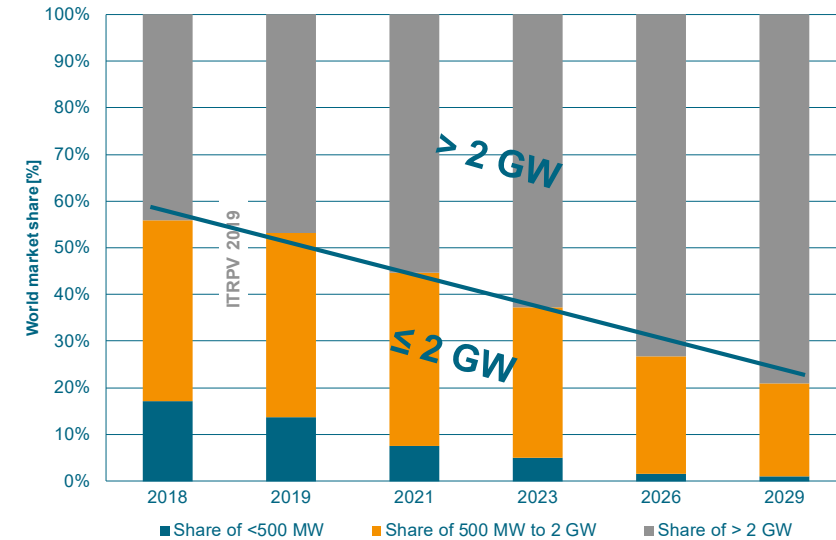


- BSF p-type cells mc-Si
- ◆ BSF cells p-type mono-Si
- leading product (PERC, PERL or PERT cells including w/ passivated contacts at rear side) p-type mc-Si
- ◆ leading product (PERC, PERL or PERT cells including w/ passivated contacts at rear side) p-type mono-Si
- ◆ leading product (PERC, PERL or PERT cells including w/ passivated contacts at rear side) n-type mono-Si
- Silicon heterojunction (SHJ) cells n-type mono-Si
- ▲ back contact cells n-type mono-Si

	2018	2023	2029
mc-Si PERC:	20.2%	21.0%	22.0%
p-mono PERC:	22.0	23.0	23.5%
n-mono PERX:	22.0%	23.2%	24.0% → passivated contacts
SHJ:	23.0%	24.0%	25.0%

Trend: Cell fab size

→ 2GW will be min. Fab size



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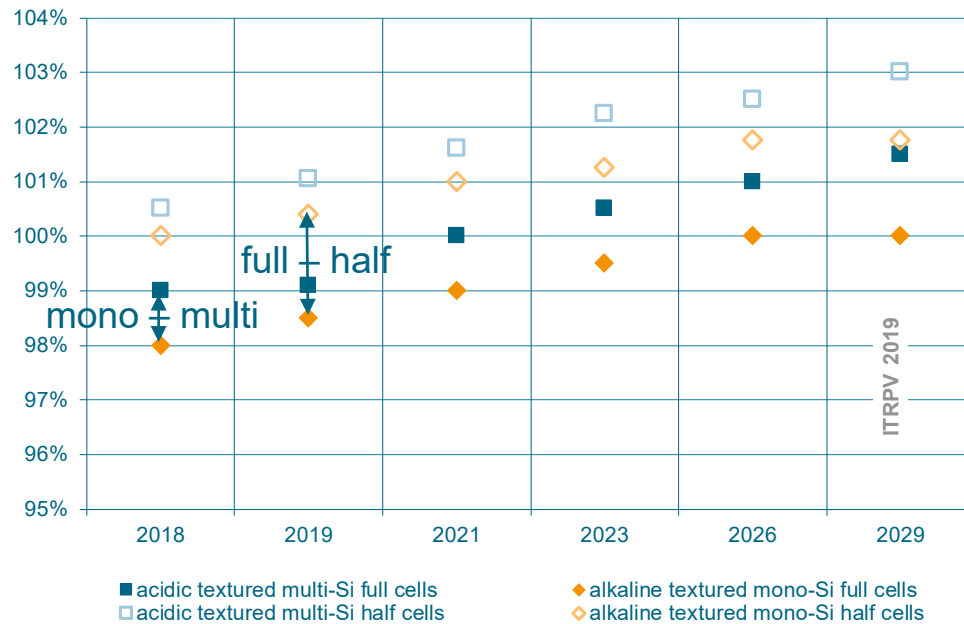
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Module: Product – CTM and module power in mass production



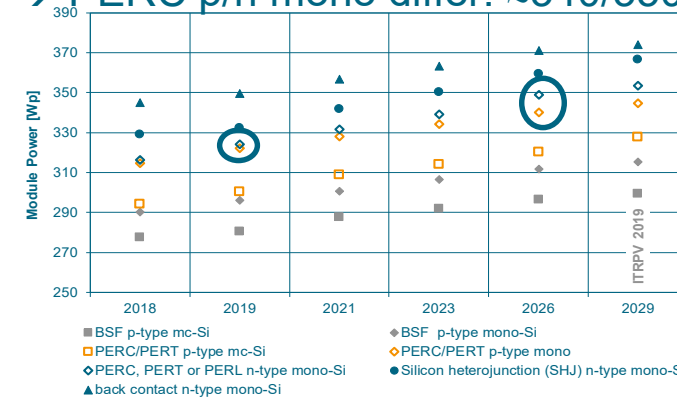
Trend: CTM

- ≈1% difference mc- / mono Si
- ≈2% CTM boost for half cell modules



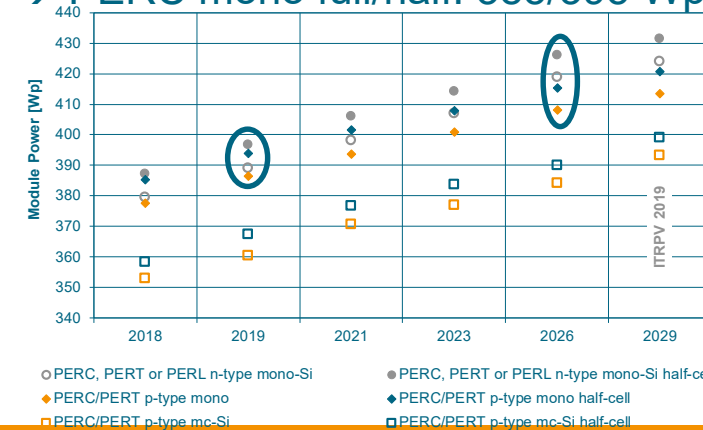
Trend: Module power 60 (full) cell modules

- 2019 → PERC p/n mono closely: ≈320/320 Wp
- 2026 → PERC p/n mono differ: ≈340/350 Wp



Trend: module power 72 cell modules

- 2019 → half cell: + 1..2 class more power
- 2019 → PERC mono full/half: 385/395 Wp → 2026: n half: 425Wp



Module: Product – MES / product warranty

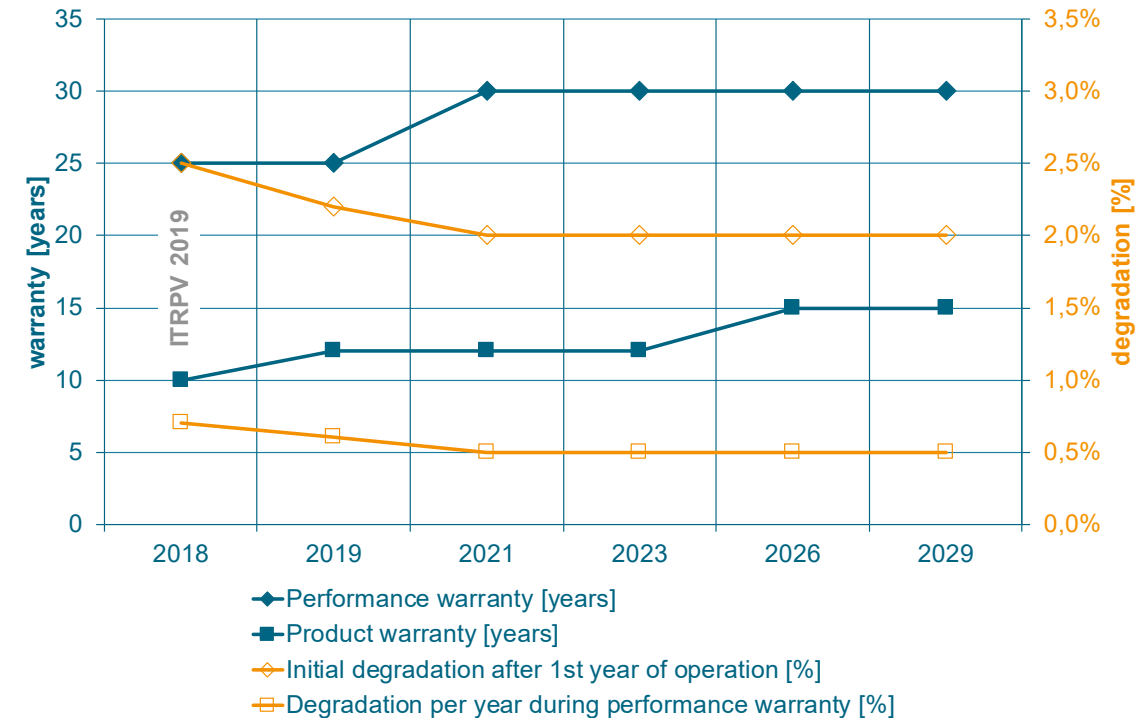
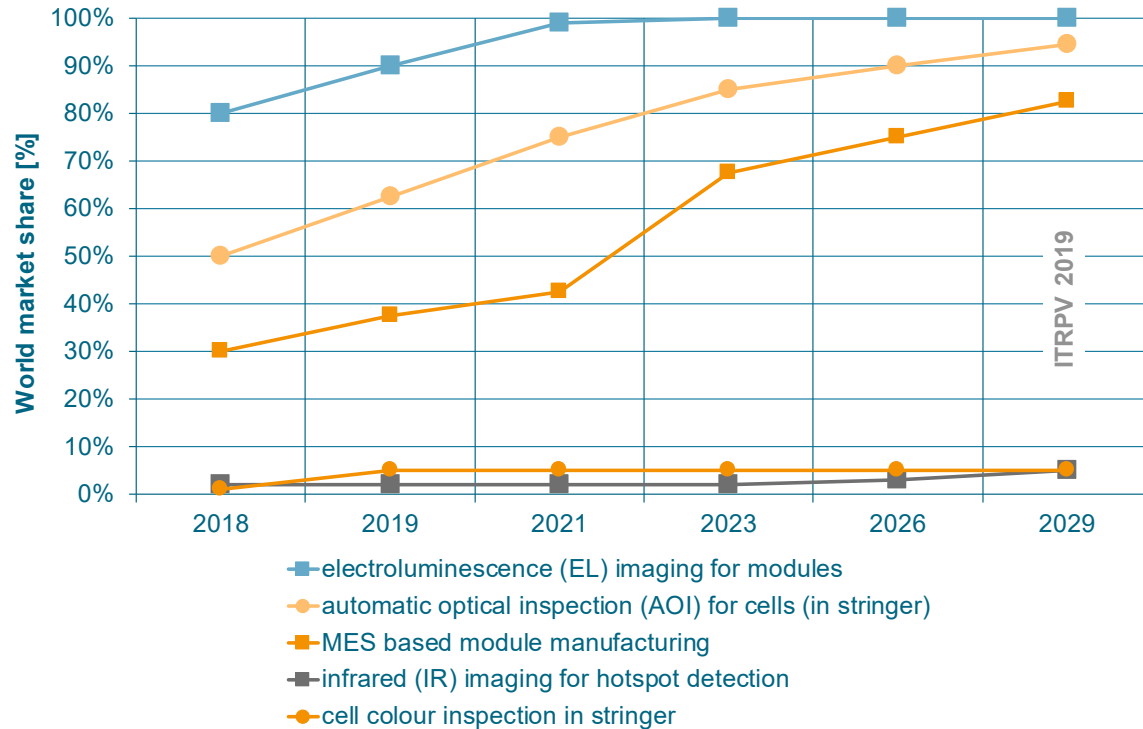


Trend: in-line inspection in module lines

- EL is standard
- AOI is in implementation

Trend: product warranty

- 1st year warranty: 2% in 2021
- performance warranty: 30y in 2021
- product warranty: 15y in 2021



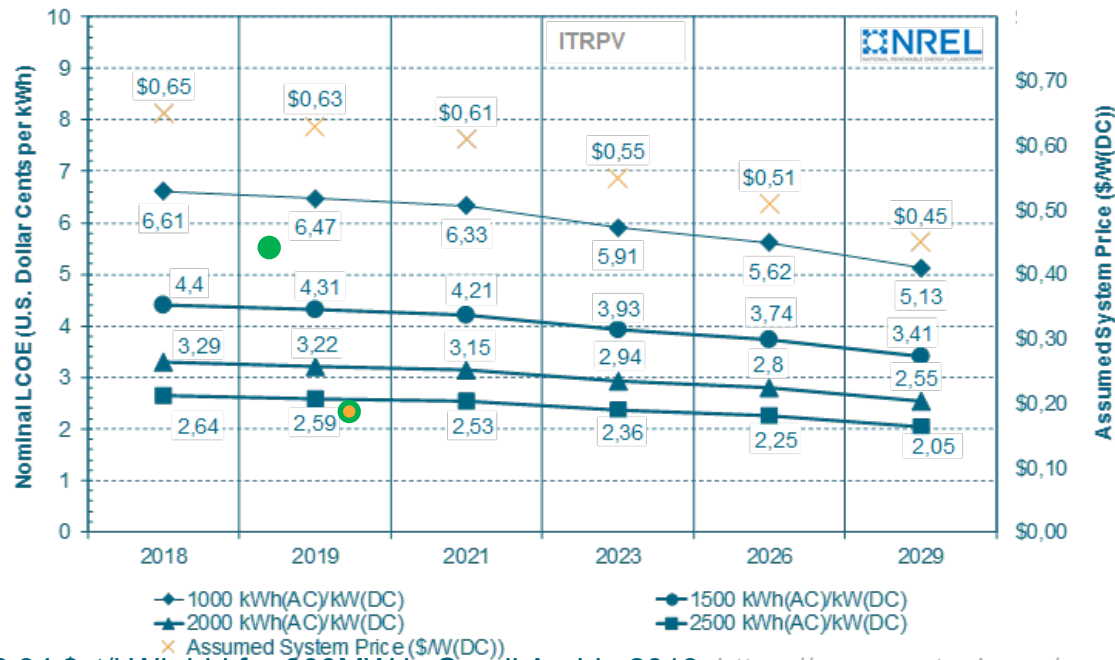
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Systems: LCOE and system trends

Trend: LCO in different insolation regions



* ~\$2.34 \$ct/kWh bid for 300MW in Saudi Arabia 2019: <https://www.pv-tech.org/news/acwa-power-wins-saudi-300mw-solar-project>

** 5.7 \$ct/kWh (4.8 €ct) avg. bid February in Germany (~1000 kWh/kWp)

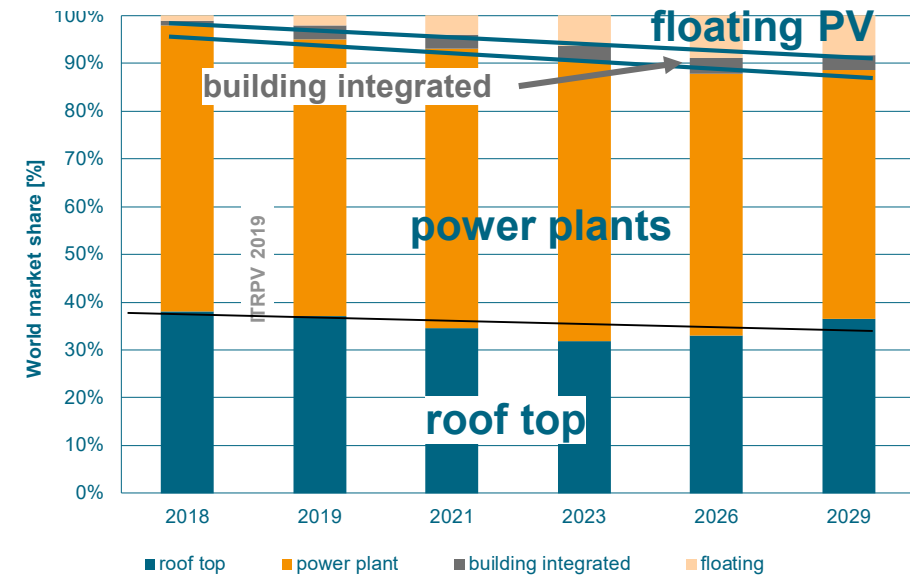
<https://www.pv-magazine.de/2019/02/15/24-zuschlaege-in-ersten-photovoltaik-ausschreibung-2019-vergeben-zuschlagswerte-erhoehen-sich-weiter-leicht/>

Trend: systems market

→ PV power plants stay dominating

→ roof top market will stay at ~35%

→ floating PV will grow



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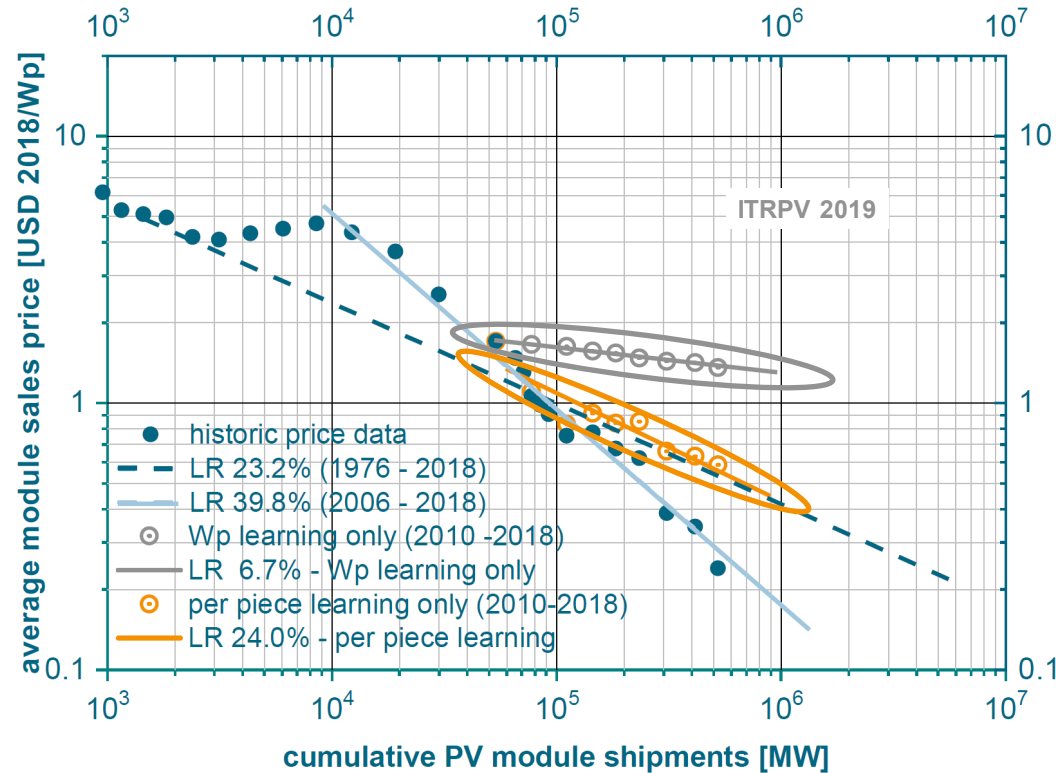


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Outlook: a look at PV today and in future



Learning curve:



ITRPV finding:



2010-2018 Wp and per piece updated:

Wp learning rate: ~ 6.7% (last year 4%)
per piece learning rate: ~ 24.0% (last year 7%)

conclusion:

→ Learning was and will be always a combination of

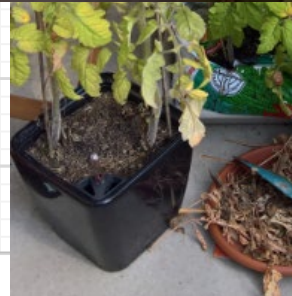
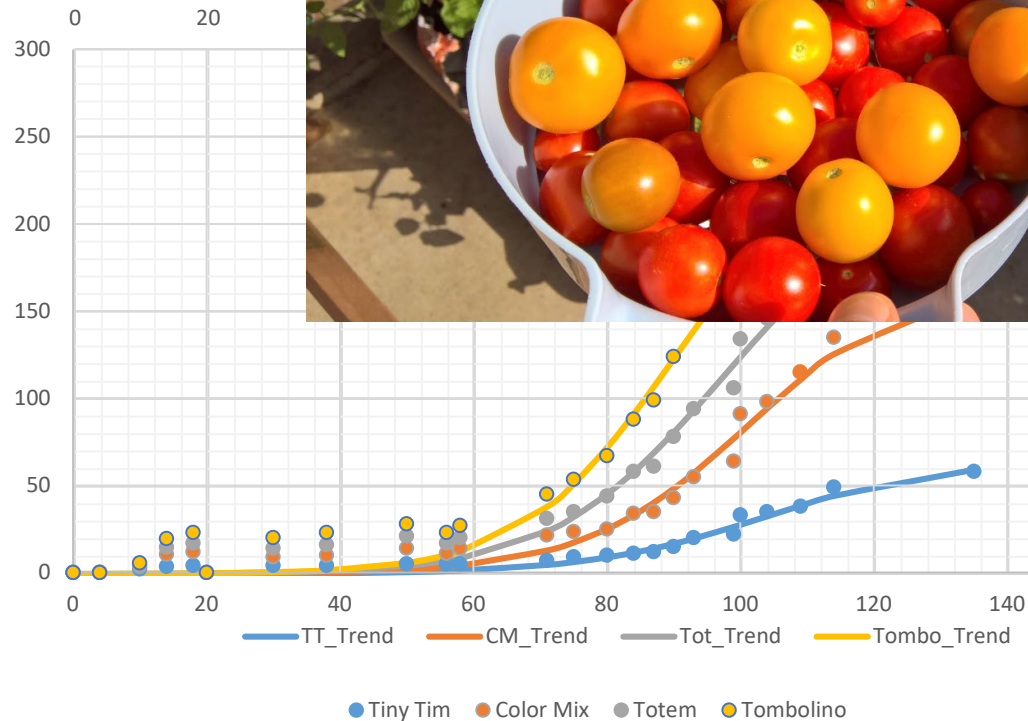
efficiency increase
+ continues cost reduction per piece
= cost reduction of PV generated electricity

→ Wp increase w/o cost increases will remain challenging

→ But how will PV proceed in future?

logistic growth approach is limited

Outlook: status on PV growth experiments



→ I continue logistic growth studies but with larger diversification 😊

Outlook and summary - PV today and in future

Different calculated scenarios in 10th edition:

IEA

low: 4.5 TWp/ 7 PWh (16% global electricity)
market peak: 300+GWp / 2030

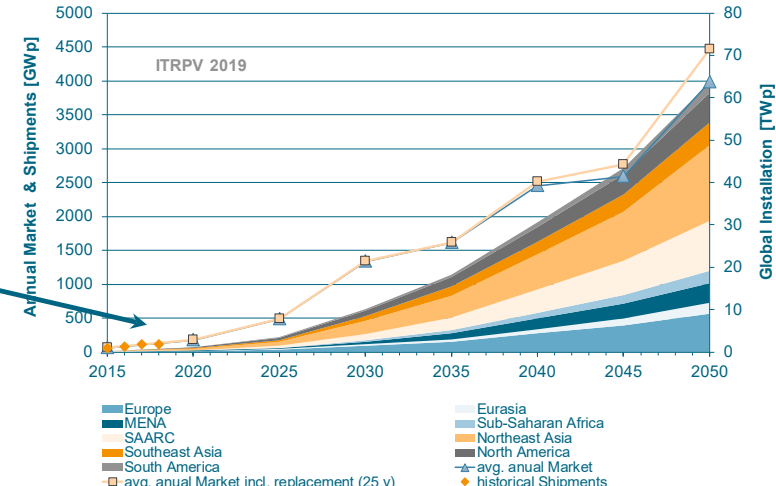
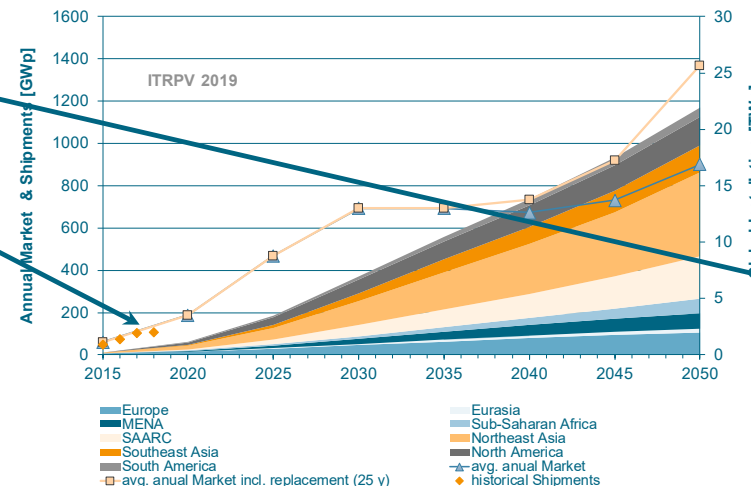
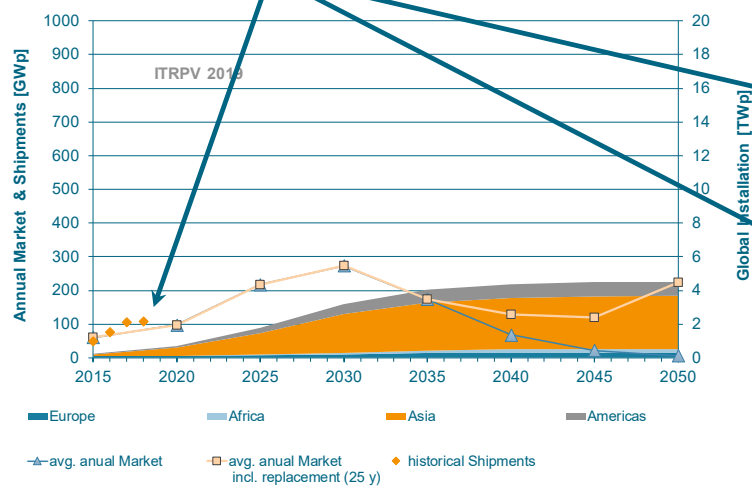
Breyer ("Electricity")

high: 22 TWp/ 38 PWh (69% global electricity)
market peak: 1,400+GWp / 2050

Breyer ("Broad electrification")

mix: 63 TWp/ 104PWh (69% global energy)
market peak: 4,500+ GW / 2050

→ Shipments 2018 were close to approaches!



ITRPV finding:

- PV learning continues and progresses but market will remain volatile
- Several 100GW markets are ahead, and can be served based on today's PV technologies
- Further effort is required to meet 2030+ / xTWp market requirements!



ITRPV provides a guideline to handle the technology challenges



Thank you
Thank you
for your attention!
to all contributors!

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